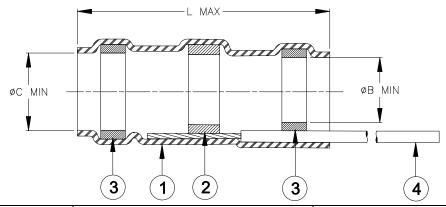
CUSTOMER DRAWING



Product	Pi	roduct Dimension	ns	Cable Dimensions			
Name	øB	øС	L	øD	øE	J ±0.50	
	min	min	max	max	min	[J ±0.020]	
B-023-00-55-22-9	4.30 [0.169]	5.60 [0.220]	31.00	4.30	3.00	5.00	
B-023-00-33-22-9			[1.220]	[0.169]	[0.118]	[0.197]	
B-023-07-55-22-9	3.10 [0.122]	4.50 [0.177]	29.00	3.10	2.40	6.00	
D-023-07-33-22-9			[1.142]	[0.122]	[0.094]	[0.236]	

MATERIALS

- 1. INSULATION SLEEVE: Heat-shrinkable, transparent clear, modified polytetrafluorethylene.
- 2. SOLDER PREFORM WITH FLUX:

SOLDER: TYPE Pb93 per ANSI/J-STD-006.

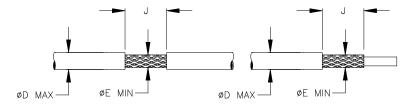
FLUX: TYPE ROM1 per ANSI/J-STD-004.

- 3. MELTABLE SEALING RINGS: Modified fluorinated ethylene propylene.
- 4. GROUND LEAD: Tyco Electronics/Raychem 55PC0813-22-9, nickel-plated copper, AWG 22, Color white.

APPLICATION

- 1. These controlled soldering devices are designed for termination of a nickel-plated copper shield of a cable having an insulation rated for at least 200°C continuous.
- 2. Temperature range: -65°C to +200°C.
- 3. Install using TE Connectivity-approved convection heating tools or equivalent.

For best results, prepare the cable as shown:



TE Connectivity, TE connectivity (logo), Raychem, and SolderSleeve are trademarks

<i>≡<u>т</u>Е</i>			Raychem Devices	SOLDERSLEEVE DEVICE SHIELD TERMINATION WITH PRE-INSTALLED LEAD HIGH TEMPERATURE					
Unless otherwise specified dimensions are in millimeters. [Inches dimensions are shown in brackets]				DOCUMENT NO.: B-023-XX-55-22-9					
TOLERANCES: 0.00 N/A 0.0 N/A 0 N/A		ES: N/A HNESS IN DN	TE Connectivity reserves the this drawing at any time. Use the suitability of the product application.		sers should evaluate	Revision: C		Issue Date: April 2020	
PREPARED BY M. Forond	200		ECO : EO	CO-20-004960	CAGE CODE : 06090	SCALE: None	SIZE: A	SHEET: 1 of 1	